

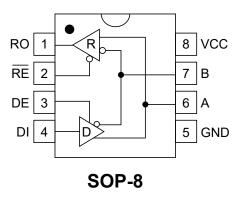
1.Description

The UMW MAX485 is low-power transceivers for RS-485 and RS- 422 communication. IC contains one driver and one receiver. The driver slew rates of the MAX485 is not limited, allowing them to transmit up to 2.5Mbps. These transceivers draw between 120µA and 500µA of supply current when unloaded or fully loaded with disabled drivers. All parts operate from a single 5V supply. Drivers are short-circuit current limited and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs into a high-impedance state. The receiver input has a fail-safe feature that guarantees a logic-high output if the input is open circuit. The MAX485 is designed for half- duplex applications.

2.Features

- Low Quiescent Current: 300µA
- -7V to +12V Common-Mode Input Voltage Range
- Three-State Outputs
- 30ns Propagation Delays, 5ns Skew
- Full-Duplex and Half-Duplex Versions Available
- Operate from a Single 5V Supply
- Allows up to 32 Transceivers on the Bus
- Data rate: 2,5 Mbps
- Current-Limiting and Thermal Shutdown for
- Driver Overload Protection

3. Pinning information









4.Absolute Maximum Ratings

Description	Symbol	Rating
Supply Voltage		7V
Control Input Voltage	- V _{cc}	-0.5V to (V _{CC} + 0.5V)
Driver Input Voltage	DI	-0.5V to (V _{CC} + 0.5V)
Driver Output Voltage	- A, B	-8V to +12.5V
Receiver Input Voltage	A, B	-8V to +12.5V
Receiver Output Voltage	RO	-0.5V to (V _{cc} +0.5V)
Continuous Power Dissipation		T _A =70°C
8-Pin Plastic DIP (derate 9.09mW/°C above +70°C)		727mW
8-Pin SO (derate 5.88mW/°C above +70°C)		471mW
Operating Temperature Ranges		-40°C to +105°C
Storage Temperature Range		-65°C to +160°C
Lead Temperature (soldering, 10sec)		300°C



5.Electrical Characteristics

(V_{CC}=5V±5%, $T_{A}\text{=}T_{MIN}$ to $T_{MAX},$ unless otherwise noted.) (Notes 1, 2)

Parameter	Symbol	Conditio	Min	Тур	Max	Units	
Differential Driver Output (noload)	V _{OD1}					5	V
Differential Driver Output (with lead)	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	R=50Ω (RS-422)	2			V	
Differential Driver Output (with load)	V _{OD2}	R=27Ω (RS-485),	Figure 4	1.5		5	V
Change in Magnitude of Driver Differential							
Output Voltage for Complementary Output	ΔV_{OD}	R=27 Ω or 50 Ω , Fig	gure 4			0.2	V
States							
Driver Common-Mode Output Voltage	V _{oc}	R=27Ω or 50Ω, Fig	gure 4			3	V
Change in Magnitude of Driver Common-							
Mode Output Voltage for Complementary	ut Voltage for Complementary ΔV_{OD} R=27 Ω or 50 Ω , Figure 4					0.2	V
Output States							
Input High Voltage	V _{IH}	DE, DI, RE	2			V	
Input Low Voltage	V _{IL}	DE, DI, RE			0.8	V	
Input Current	I _{IN1}	DE, DI, RE			±2	μΑ	
Input Current (A, B)	I _{IN2}	DE=0V	V _{IN} =12V			1	mA
input Guirent (A, B)		V _{CC} = 0V or 5.25V	V _{IN} =-7V			-0.8	mA
Receiver Differential Threshold Voltage	V _{TH}	-7V ≤V _{CM} ≤12V		-0.2		0.2	V
Receiver Input Hysteresis	ΔV_{TH}	V _{CM} =0V			70		mV
Receiver Output High Voltage	V _{OH}	I _O =-4mA,V _{ID} =200mV		3.5			V
Receiver Output Low Voltage	V _{OL}	I _O = 4mA, V _{ID} =-200mV				0.4	V
Three-State (high impedance)		I _{OZR} 0.4V≤ V _O ≤ 2.4V				±1	μA
Output Current at Receiver	IOZR					- '	μΛ
Receiver Input Resistance	R _{IN}	-7V≤V _{CM} ≤ 12V					ΚΩ









6.DC Electrical Characteristics (continued)

(V_{CC}=5V ±5%, $T_A = T_{MIN}$ to $T_{MAX},$ unless otherwise noted.) (Notes 1, 2)

Parameter	Symbol	Conditions	Min	Тур	Max	Units
		DE=V _{cc}		500	900	
No-Load supply Current (Note 3)	I _{cc}	RE=0V or V _{cc}		300	500	μΑ
		DE=0V				μΑ
Driver Short-Circuit Current						
	I _{OSD1}	-7V≤ V ₀ ≤ 12V (Note 4)	35		250	mA
V _o =High						
Driver Short-Circuit Current						
	I _{OSD2}	-7V≤ V ₀ ≤12V (Note 4)	35		250	mA
V _O =LoW						
Receiver Short-Circuit Curent	I _{OSR}	0V≤ V _O ≤ V _{CC}	7		95	mA







7. Switching Characteristics

(V_CC=5V±5%, $T_A = T_{MIN}$ to $T_{MAX},$ unless otherwise noted.) (Notes 1, 2)

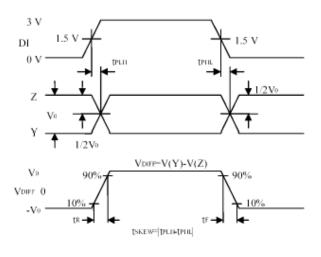
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Driver input to Output	t _{PLH}	t_{PLH} R_{DIFF} =54 Ω		30	60	ns
Driver input to Output	t _{PHL}	t _{PHL} C _{L1} =C _{L2} =100pF			60	ns
Driver Output Skew to Qutput	t _{SKEW}	R_{DIFF} =54 Ω , C_{L1} = C_{L2} =100pF		5	10	ns
Driver Enable to Output High	t _{zH}	C _L =100pF, S2 closed		40	70	ns
Driver Enable to Output Low	t _{zL}	C _L =100pF, S1 closed		40	70	ns
Driver Disable Time from Low	t _{LZ}	C _L =15pF, S1 closed		40	70	ns
Driver Disable Time from High	t _{HZ}	C _L =15pF, S2 closed		40	70	ns
t _{PLH} - t _{PHL} Differential	t _{SKD}	R_{DIFF} =54 Ω		13		ns
Receiver Skew		C _{L1} =C _{L2} =100pF				
Receiver Enable to Output LOW	t _{zL}	C _{RL} =15pF,S1 closed		20	50	ns
Receiver Enable to Output High	t _{zH}	C _{RL} =15pF,S2 closed		20	50	ns
Receiver Disable Time from LOW	t _{LZ}	C _{RL} =15pF,S1 closed		20	50	ns
Receiver Disable Time from High	t _{HZ}	C _{RL} =15pF,S2 closed		20	50	ns
Maximum Data Rate	f _{MAX}		2.5			Mbps

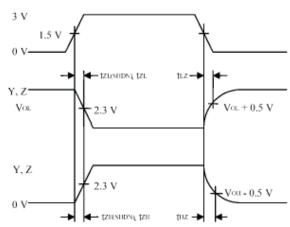


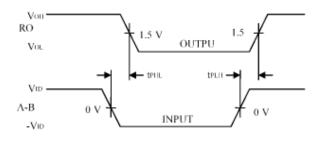


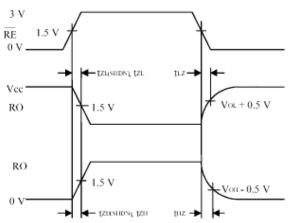


8. Operation Timing Diagrams of MAX 485















9. Table of MAX 485 Operation

	Т	ransmissio	n		Rec	eipt		
	Inputs			Outputs X		Inputs		
RE	DE	DI	В	А	RE	DE	A-B	RO
Х	1	1	0	1	0	0	≥+0.2V	1
Х	1	0	1	0	0	0	≤-0.2V	0
0	0	Х	Z	Z	0	0	open	1
1	0	Х	Z	Z	1	0	Х	Z

Notes:

X-don't care

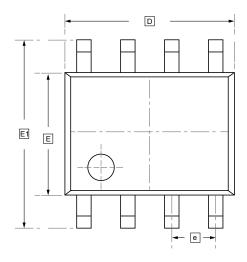
Z-high resistance

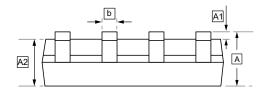


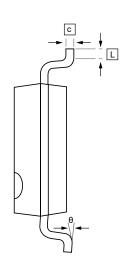




10.SOP-8 Package Outline Dimensions







DIMENSIONS (mm are the original dimensions)

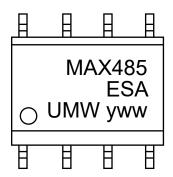
Symbol	Α	A 1	A2	b	C	D	Е	E1	е	L	θ
Min	1.350	0.000	1.350	0.330	0.170	4.700	3.800	5.800	1.270	0.400	0°
Max	1.750	0.100	1.550	0.510	0.250	5.100	4.000	6.200	BSC	1.270	8°







11.Ordering information



yy: Year Code ww: Week Code

Order Code	Package	Base QTY	Delivery Mode
UMW MAX485ESA	SOP-8	2500	Tape and reel







12.Disclaimer

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